

**INFORMATION DISCLOSURE CITATION**  
(Use several sheets if necessary)

Docket Number (Optional)  
**FIS9-2001-0168US1**

Application Number

Applicant(s)  
**DALTON ET AL.**

Filing Date

Group Art Unit  
**2823**

JP978 U.S. PRO  
10/053286  
01/17/02

**U.S. PATENT DOCUMENTS**

*EXAMINER INITIAL	REF	DOCUMENT NUMBER	DATE	NAME	CLASS	SUBCLASS	FILING DATE IF APPROPRIATE
Lee		6,121,150	09-19-00	AVANZINO ET AL.	438	692	
		6,165,695	12-26-00	YANG ET AL.	430	314	
		6,162,587	12-19-00	YANG ET AL.	430	314	
		6,140,226	10-31-00	GRILL ET AL.	438	637	
		6,019,906	02-01-00	JANG ET AL.	216	2	
Lee		6,066,569	05-23-00	TOBBEN	438	717	

**FOREIGN PATENT DOCUMENTS**

	REF	DOCUMENT NUMBER	DATE	COUNTRY	CLASS	SUBCLASS	Translation	
							YES	NO
Lee		10-92791	04-10-98	JAPAN	H01L	21/3065		

**OTHER DOCUMENTS** (Including Author, Title, Date, Pertinent Pages, Etc.)

Lee		U.S. Appl. No. 09/550,943, filed April 17, 2000, entitled "Protective Hardmask for Producing Interconnect Structures", Dalton et al.

EXAMINER

DATE CONSIDERED

EXAMINER: Initial if citation considered, whether or not citation is in conformance with MPEP Section 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.